A00502-02STG

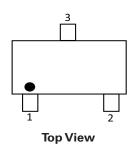
5 V, 1.0 pF, SOT723, Unidirectional TVS, Low Capacitance ESD protection



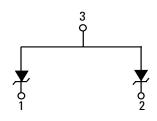


Note: This package image is for example and reference only. for detail package drawing, please refer to the package section in this datasheet.

Pinout



Functional Block Diagram



Description

The AQ0502-02STG provides low capacitance, 2 channel unidirectional and a high level of protection for electronic equipment that may experience destructive electrostatic discharges (ESD). The typical capacitance of 1.0 pF helps ensure excellent signal integrity on the most challenging consumer electronics interfaces, such as USB2.0, 10/100/1000 Ethernet, Display port.

It can safely absorb repetitive ESD strikes at ± 22 kV (contact discharge, IEC 61000-4-2) without performance degradation and safely dissipate 2.5 A of 8/20 μ s surge current (IEC 61000-4-5 2^{nd} edition).

Features

- ESD, IEC 61000-4-2, ±22 kV contact, ±27 kV air
- ESD, ISO10605 330 pF 330 Ω, ±20 kV contact/air
- EFT, IEC 61000-4-4, 40 A (5/50 ns)
- Maximum surge tolerance, IEC 61000-4-5 2nd edition, 2.5 A (8/20 µs)
- Low capacitance of 1 pF@1 MHz (TYP@V_R = 0 V)

- Low leakage current of 1 nA (TYP) at 5.0 V
- Halogen-free, lead-free and RoHS compliant
- Moisture sensitivity level (MSL-1)
- AEC-Q101 qualified and PPAP capable

Applications

- Automotive
- USB2.0

- Display port
- 10/100/1000 Ethernet

Life Support Note:

Not Intended for Use in Life Support or Life Saving Applications

The products shown herein are not designed for use in life sustaining or life saving applications unless otherwise expressly indicated.



AQ0502-02STG

5 V, 1.0 pF, SOT723, Unidirectional TVS, Low Capacitance ESD protection

Absolute Maximum Ratings

Symbol	Parameter	Value	Units
I _{PP}	Peak Current (t _p = 8/20 μs)	2.5	А
T _{OP}	Operating Temperature	-40 to 150	°C
T _{STOR}	Storage Temperature	-55 to 150	°C

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the component. This is a stress only rating and operation of the component at these or any other conditions above those indicated in the operational sections of this specification is not implied.

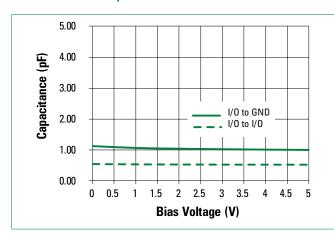
Electrical Characteristics (T_{OP} = 25 °C)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Units
Reverse Standoff Voltage	V _{RWM}				5	V
Breakdown Voltage	V _{BR}	I _R = 1 mA		8.2		V
Reverse Leakage Current	I _{LEAK}	$V_R = 5 V$		1	50	nA
Clamp Voltage ¹	V _C	$I_{pp} = 1 \text{ A, } t_p = 8/2 \text{ 0}\mu\text{s, I/O to GND}$		10.5		V
		$I_{pp} = 2.5 \text{ A}, t_p = 8/20 \mu\text{s}, I/O \text{ to GND}$		12.8		V
Dynamic Resistance 1.2	R _{DYN}	TLP, $t_p = 100 \text{ ns}$, I/O to GND		0.70		Ω
ESD Withstand Voltage ^{1,3,4}	V _{ESD}	IEC 61000-4-2 (Contact Discharge)	±22			kV
		IEC 61000-4-2 (Air Discharge)	±27			kV
		ISO10605 (Contact Discharge)	±20			kV
		ISO10605 (Air Discharge)	±20			kV
Diode Capacitance ¹	C _{IO-GND}	Reverse Bias = 0 V, f =1 MHz, I/O to GND		1.0		pF
	C _{IO-IO}	Reverse Bias = 0 V, f = 1 MHz, I/O to I/O		0.6		pF

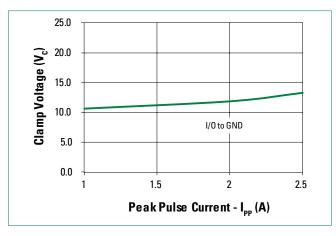
Note:

- 1. Parameter is guaranteed by design and/or component characterization.
- 2. Transmission Line Pulse (TLP) with 100ns width, 0.2 ns rise time, and average window t1 = 70 ns to t2 = 90 ns
- 3. Device stressed with ten non-repetitive ESD pulses according to IEC61000-4-2 (R $\,$ = 330 $\,$ Ω , C $\,$ = 150 pF).
- 4. Device stressed with three non-repetitive ESD pulses according to ISO10605 (R = 330 Ω , C = 330 pF).

Capacitance vs. Reverse Bias



Clamping Voltage vs $I_{_{\rm PP}}$

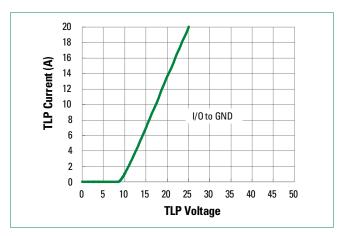




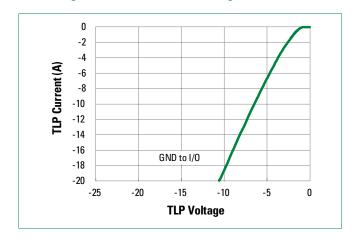
AQ0502-02STG

5 V, 1.0 pF, SOT723, Unidirectional TVS, Low Capacitance ESD protection

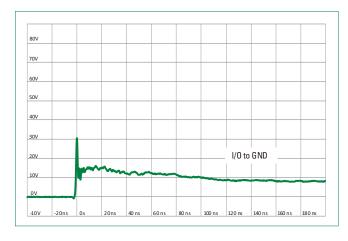
Positive Transmission Line Pulsing (TLP) Plot



Negative Transmission Line Pulsing (TLP) Plot



IEC 61000-4-2 +8 kV Contact ESD Clamping Voltage



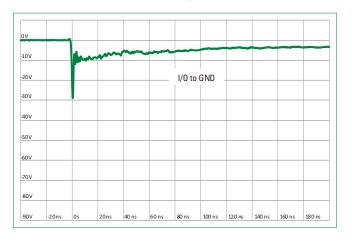
IEC 61000-4-2 -8 kV Contact ESD Clamping Voltage



ISO10605 Contact Discharge Plot at +8 kV



ISO10605 Contact Discharge Plot at -8 kV





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5 V, 1.0 pF, SOT723, Unidirectional TVS, Low Capacitance ESD protection

Soldering Parameters

Reflow Condition		Pb — free assembly	
Pre Heat	- Temperature Min (T _{s(min)})	150 °C	
	- Temperature Max (T _{s(max)})	200 °C	
	-Time (min to max) (t _s)	60 - 120 seconds	
Average Ramp Up Rate (Liquidus) Temp (T_L) to Peak		3 °C/second max	
T _{S(max)} to T	լ - Ramp-up Rate	3 °C/second max	
Reflow	- Temperature (T _L) (Liquidus)	217 °C	
	- Temperature (t _L)	60 - 150 seconds	
Peak Temperature (T _p)		260 ^{+0/-5} °C	
Time within 5 °C of Actual Peak Temperature (t _p)		30 seconds	
Ramp-down Rate		6 °C/second max	
Time 25 °C to Peak Temperature (T _p)		8 minutes max	
Do not exceed		260 °C	

Ordering Information

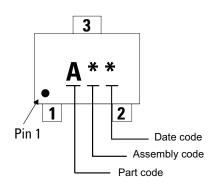
Part Number	Package	Min. Order Qty.
AQ0502-02STG	SOT723-3L	8000

T_P Ramp-up T_L T_{S(min)} Preheat T_{S(min)} Time

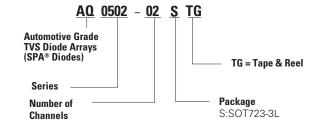
Product Characteristics

Lead Plating	Matte Tin
Lead Material	Copper Alloy
Body Material	Molded Compound
Flammability	UL recognized compound meeting flammability rating V-0

Part Marking System



Part Numbering System

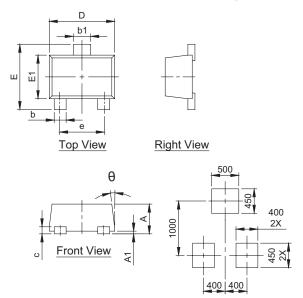




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5 V, 1.0 pF, SOT723, Unidirectional TVS, Low Capacitance ESD protection

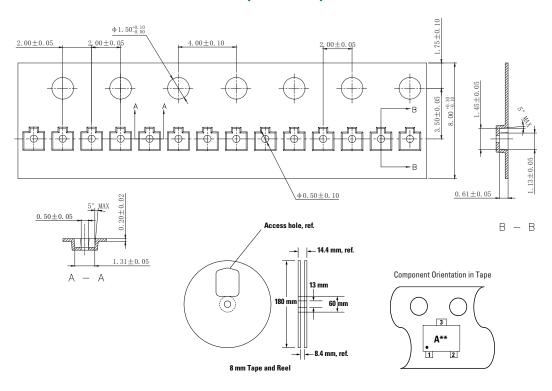
Package Dimensions — SOT723-3L



Vlax
.020
.002
0.011
0.015
.006
.049
.049
.033
С
8°
)

Recommended Soldering Pattern (unit : µm)

Embossed Carrier Tape & Reel Specification — SOT723-3L



Product Disclaimer: Littelfuse products are not designed for, and shall not be used for, any purpose (including, without limitation, automotive, military, aerospace, medical, life-saving, life-sustaining or nuclear facility applications, devices intended for surgical implant into the body, or any other application in which the failure or lack of desired operation of the product may result in personal injury, death, or property damage) other than those expressly set forth in applicable Littelfuse product documentation. Warranties granted by Littelfuse shall be deemed void for products used for any purpose not expressly set forth in applicable Littelfuse documentation. Littelfuse shall not be liable for any claims or damages arising out of products used in applications not expressly intended by Littelfuse as set forth in applicable Littelfuse documentation. The sale and use of Littelfuse products is subject to Littelfuse Terms and Conditions of Sale, unless otherwise agreed by Littelfuse. "Littelfuse" includes Littelfuse, Inc., and all of its affiliate entities. http://www.littelfuse.com/disclaimer-electronics.

